# **BAV99SEW**

### Silicon Epitaxial Planar Switching Diode



1. Anode 2. Cathode 3.Cathode / Anode

Paramet	Symbol	Value	Unit		
Repetitive Peak Reverse Voltage	9	V <sub>RRM</sub>	100	V	
Reverse Voltage	V <sub>R</sub>	100	V		
Continuous Forward Current	Single Diode Load Double Diode Load	lF	I <sub>F</sub> 150 130		
Repetitive Peak Forward Current		IFRM	500	mA	
Non-Repetitive Peak Forward Su	rge Current at t = 1 μs at t = 1 ms at t = 1 s	Ifsm	4 1 0.5	A	
Power Dissipation		PD	200	mW	
Junction Temperature		Tj	150	°C	
Storage Temperature Range	T <sub>stg</sub>	- 55 to + 150	ů		

### Absolute Maximum Ratings (T<sub>a</sub> = 25°C)

### **Thermal Characteristics**

Parameter	Symbol	Max.	Unit	
Thermal Resistance from Junction to Ambient <sup>1)</sup>	Reja	625	°C/W	

<sup>1)</sup> Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.



#### Characteristics at T<sub>a</sub> = 25°C

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 10 \ \mu A$	V <sub>BR(R)</sub>	100	-	V
Forward Voltage at I <sub>F</sub> = 1 mA at I <sub>F</sub> = 10 mA at I <sub>F</sub> = 50 mA at I <sub>F</sub> = 150 mA	VF		0.715 0.855 1 1.25	V
Reverse Current   at $V_R = 25 V$ at $V_R = 80 V$ at $V_R = 25 V$ , $T_j = 150 \circ C$ at $V_R = 80 V$ , $T_j = 150 \circ C$	IR		30 0.5 30 50	nA μA μA
Diode Capacitance at $V_R = 0$ , f = 1 MHz	Cd	-	1.5	pF
Reverse Recovery Time at I <sub>F</sub> = 10 mA, V <sub>R</sub> = 6 V, R <sub>L</sub> = 100 $\Omega$ , I <sub>RR</sub> = 0.1 × I <sub>R</sub>	trr	-	4	ns



### **Electrical Characteristics Curves**

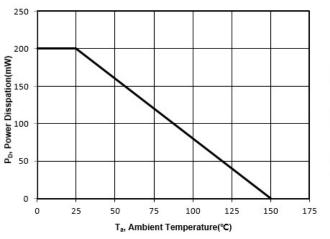


Fig 1. Power Derating Curve

Fig 2. Forward Characteristics

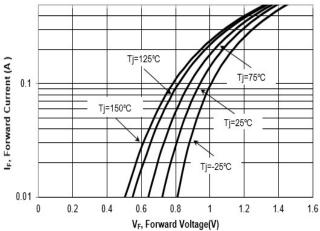
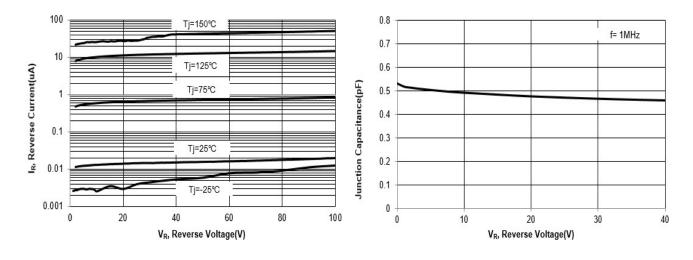


Fig 3. Reverse Current vs. Reverse Voltage

Fig 4. Total Capacitance vs. Reverse Voltage

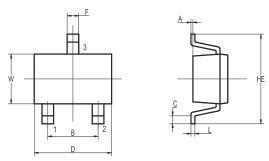


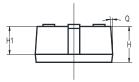


## **BAV99SEW**

### Package Outline Dimensions (Units: mm)

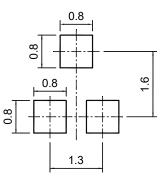
SOT-323





UNIT	А	В	С	D	Н	H1	HE	F	L	W	Q
	0.1	1.4	0.2	2.1	1.0	0.7	2.4	0.35	0.15	1.35	5°
mm	MAX.	1.2	MIN.	1.9	0.8	TYP.	2.0	0.25	0.05	1.15	MAX.

### **Recommended Soldering Footprint**



### **Packing information**

Tape Width		Pitch		Reel	Size		
Package (mm	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity	
SOT-323	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000	

### **Marking information**

- " A7" = Part No.
- " YM " = Date Code Marking
- " Y " = Year
- " M " = Month
- Font type: Arial

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